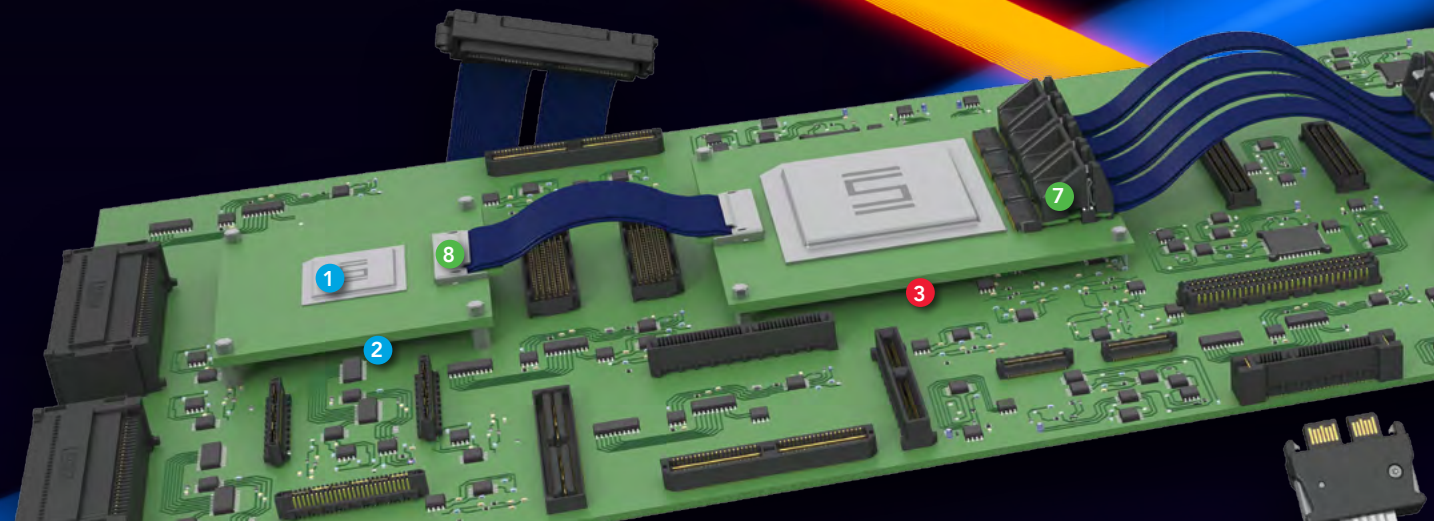
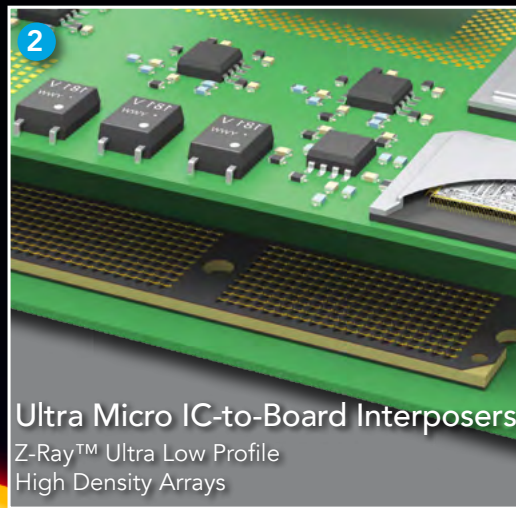


The background is dark blue with two curved, glowing lines. The upper line is orange and yellow, starting from a bright yellow starburst in the top left. The lower line is blue, starting from a bright blue starburst in the bottom left. Both lines curve across the page.

# Signal Integrity Fusion Technology + Service

# Micro Integration

IC Packaging + Micro Interposers = Streamlined Interconnect Paths



## Active Optics

Optical Design • Engineering • Interconnect Expertise



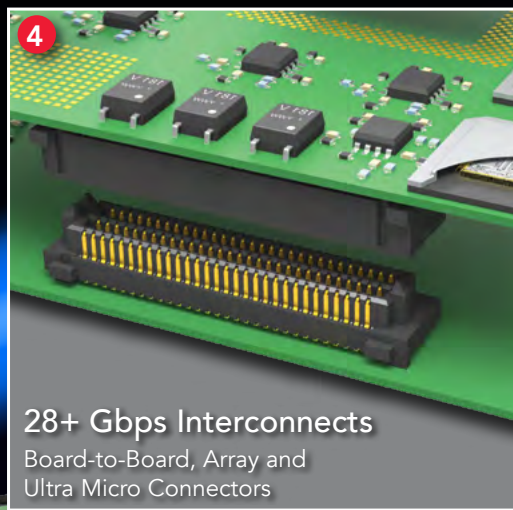
# Ultra High Speed

High Speed Board-to-Board + Arrays + Ultra Micro = 28+ Gbps Solutions



## Ultra Micro High Speed Arrays

SEARAY™ LP Low Profile  
SEARAY™ 0,80 mm Micro Pitch



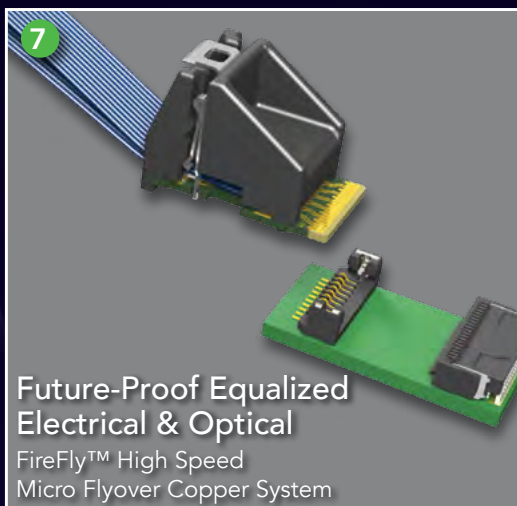
## 28+ Gbps Interconnects

Board-to-Board, Array and  
Ultra Micro Connectors



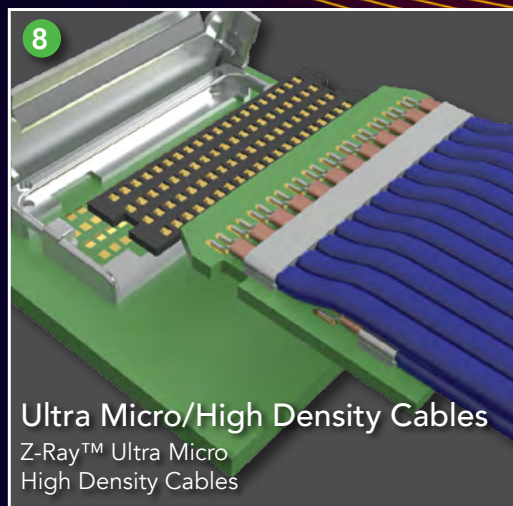
# High Speed Cables

Equalized Copper • Micro Coax • Interconnects • Optics • Future-Proof



## Future-Proof Equalized Electrical & Optical

FireFly™ High Speed  
Micro Flyover Copper System

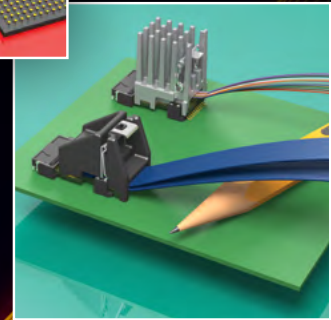
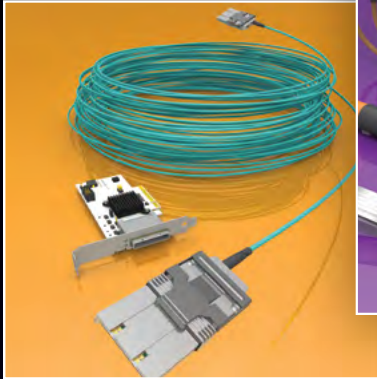
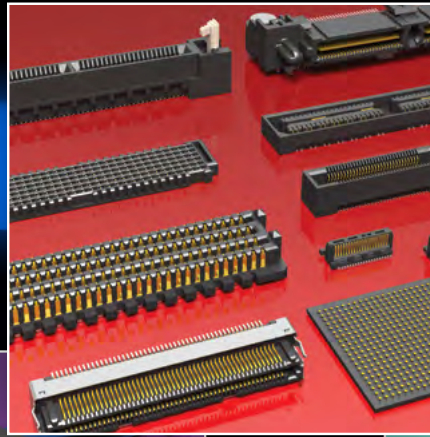


## Ultra Micro/High Density Cables

Z-Ray™ Ultra Micro  
High Density Cables

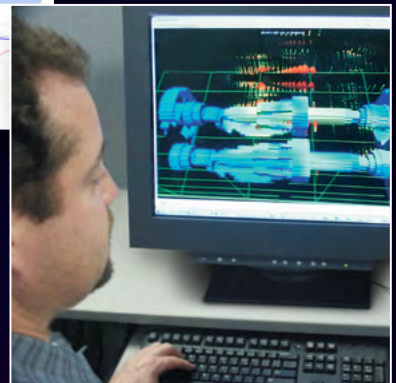
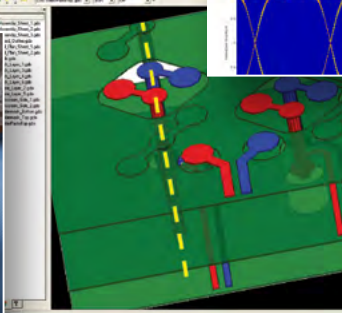
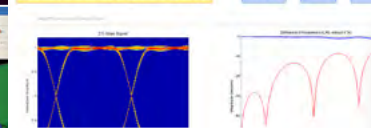
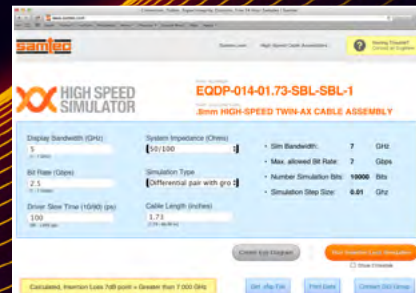
# SI Technology

- Micro packaging & IC level interconnects
- Micro & dedicated ground arrays
- Ultra micro high density cables
- Optical engine technology
- Optical and electrical flyover systems
- Future-proof interconnect solutions



# SI Service

- Precision 28+ Gbps electrical models
- Real Time SI Performance Simulator
- Customer specific channel analysis
- Industry standard protocol channel analysis
- Worldwide Signal Integrity Group
- Performance optimized PCB routing



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JANUARY 2014